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# United States Patent [19]

Pellet et al.

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[54] SEMICONDUCTOR WAFER SUPPORT

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[73] Assignee: Particle Solutions, Charlotte, N.C.

[\*\*] Term: 14 Years

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[52] U.S. Cl. .... D13/182

[58] Field of Search ..... D8/349; 174/52 FP; 357/70, 72, 74; 437/8; 118/500; 206/328, 334; 361/395; D13/182; D14/114

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[57] CLAIM

The ornamental design for a semiconductor wafer support, as shown and described.

DESCRIPTION

FIG. 1 is a front and upper right perspective view of a semiconductor wafer support showing our new design; FIG. 2 is a front and lower left perspective view thereof;

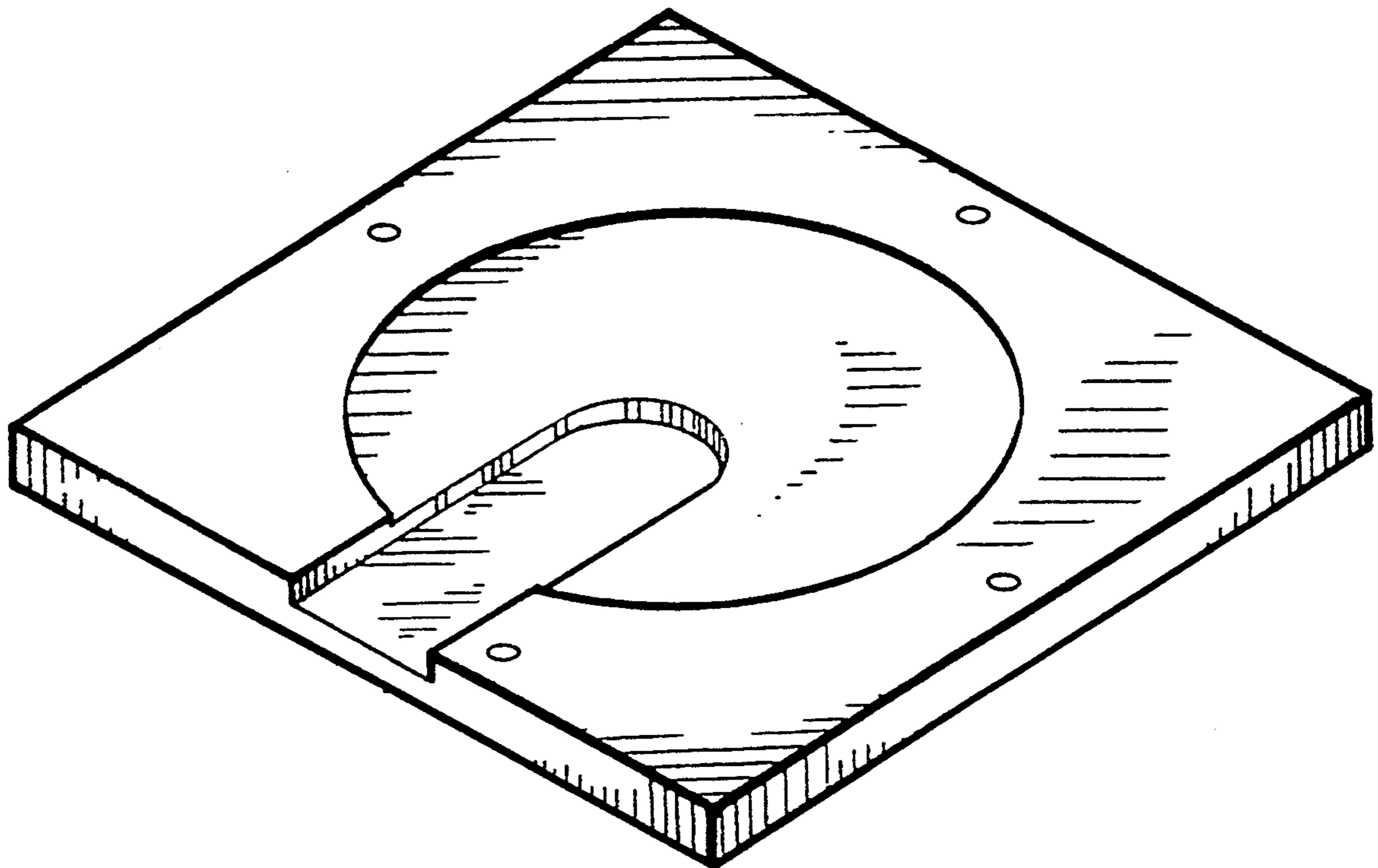
FIG. 3 is a front elevational view thereof;

FIG. 4 is a left side elevational view thereof, the right side elevational view and the rear elevational view being the same;

FIG. 5 is a top plan view thereof;

FIG. 6 is a bottom plan view thereof; and,

FIG. 7 is a top plan view of a second embodiment of a semiconductor wafer support, all other views being the same as the first embodiment except for the four apertures seen on the top and bottom.



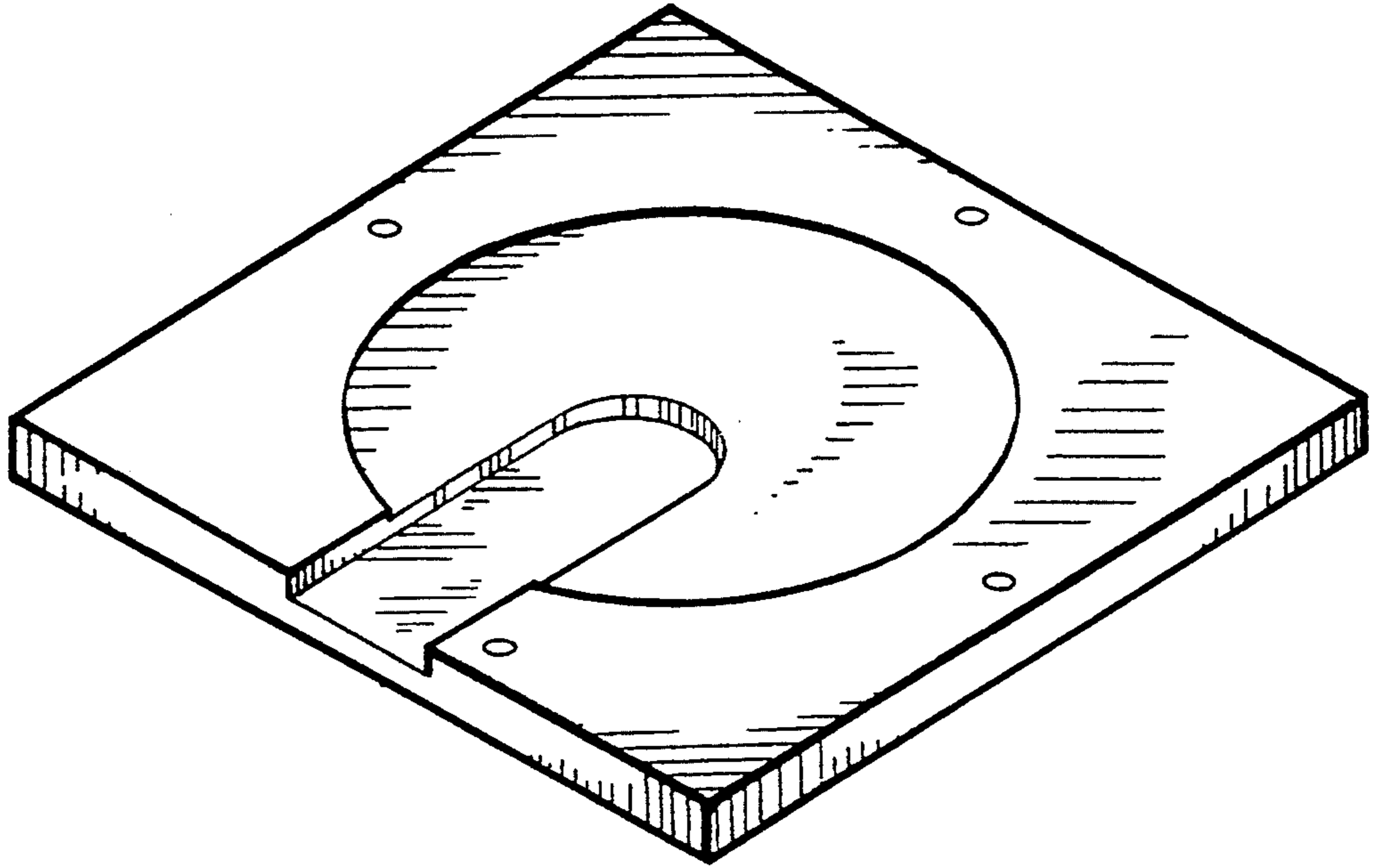


Fig. 1

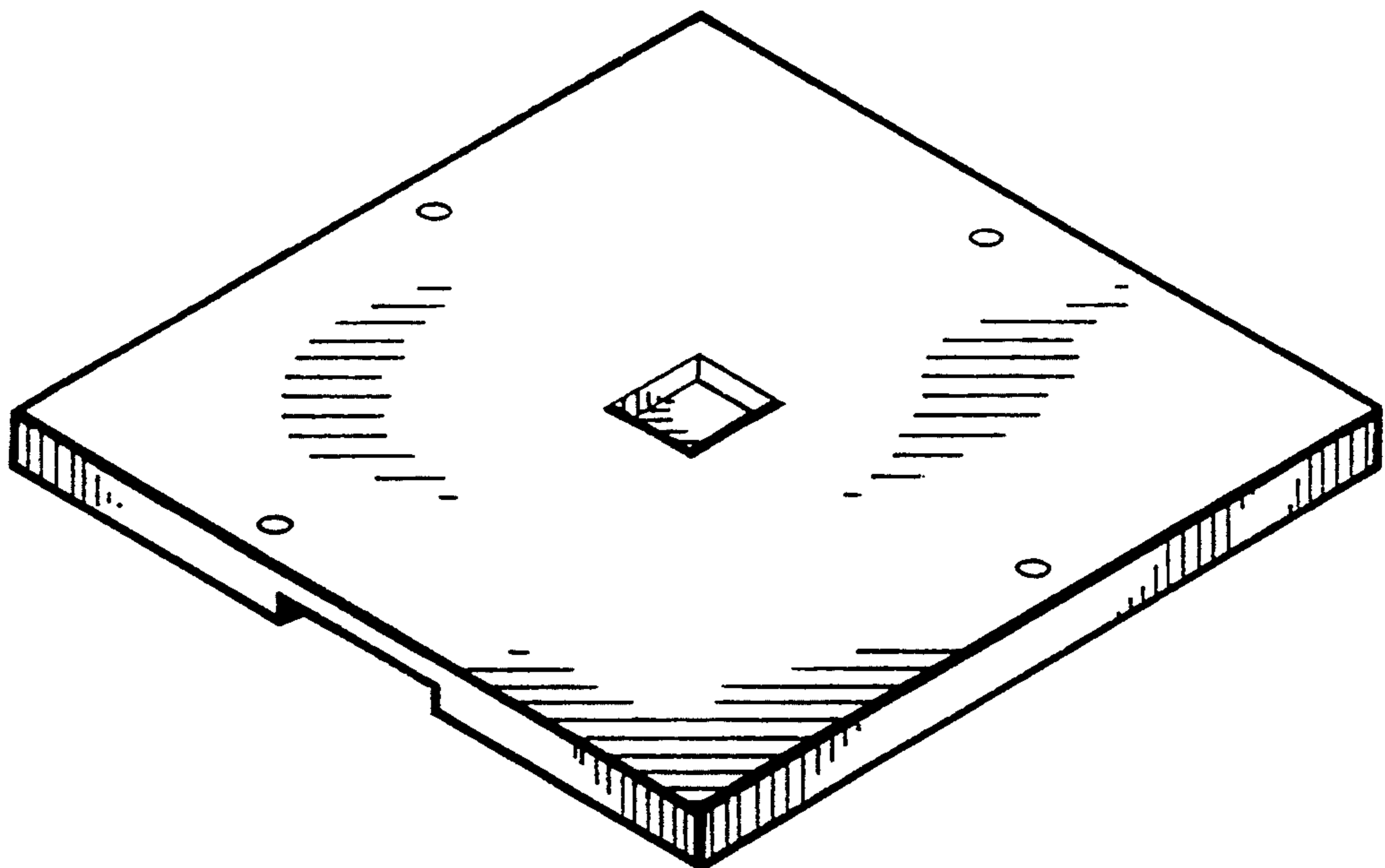


Fig. 2



Fig. 3



Fig. 4

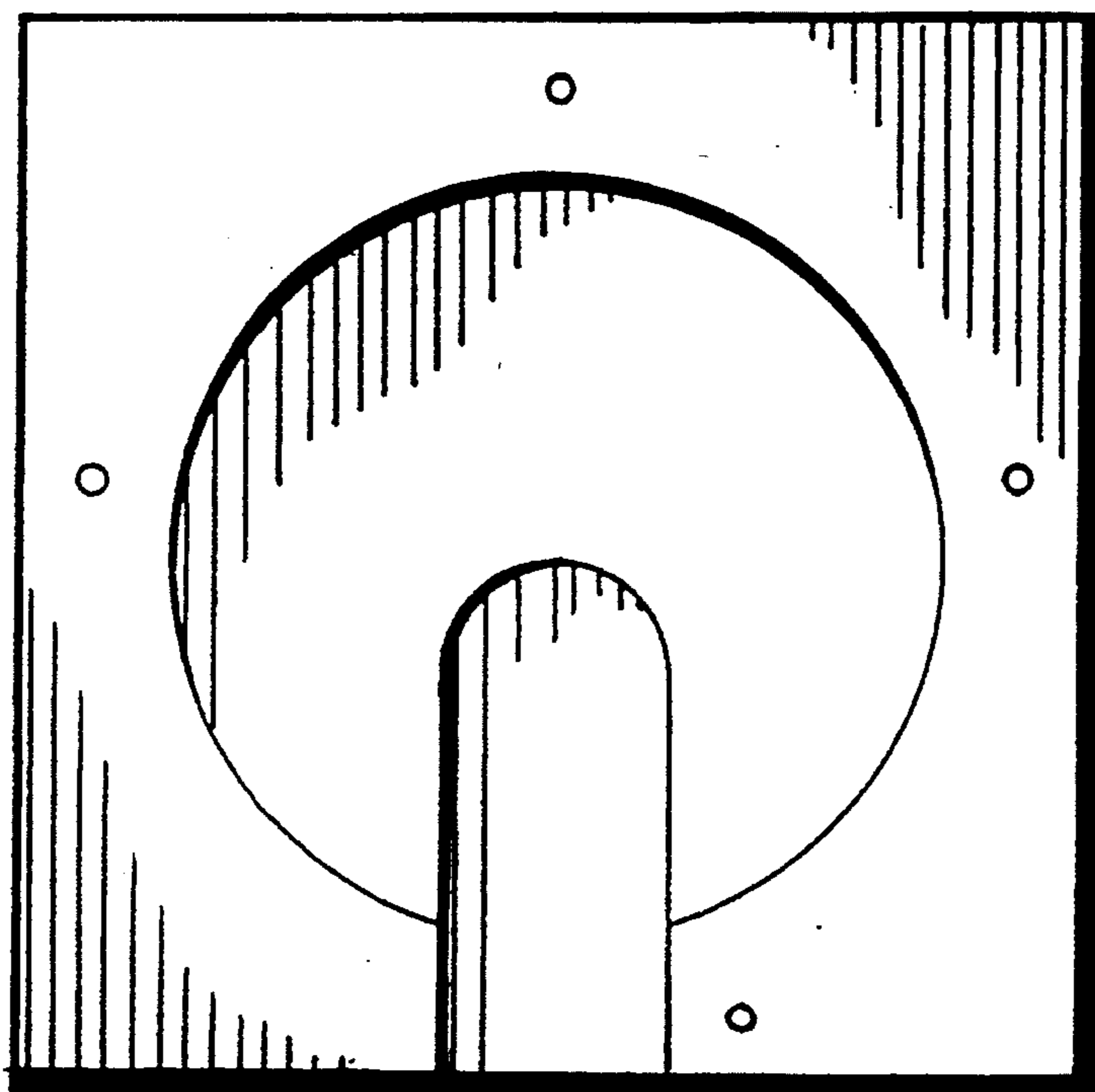


Fig. 5

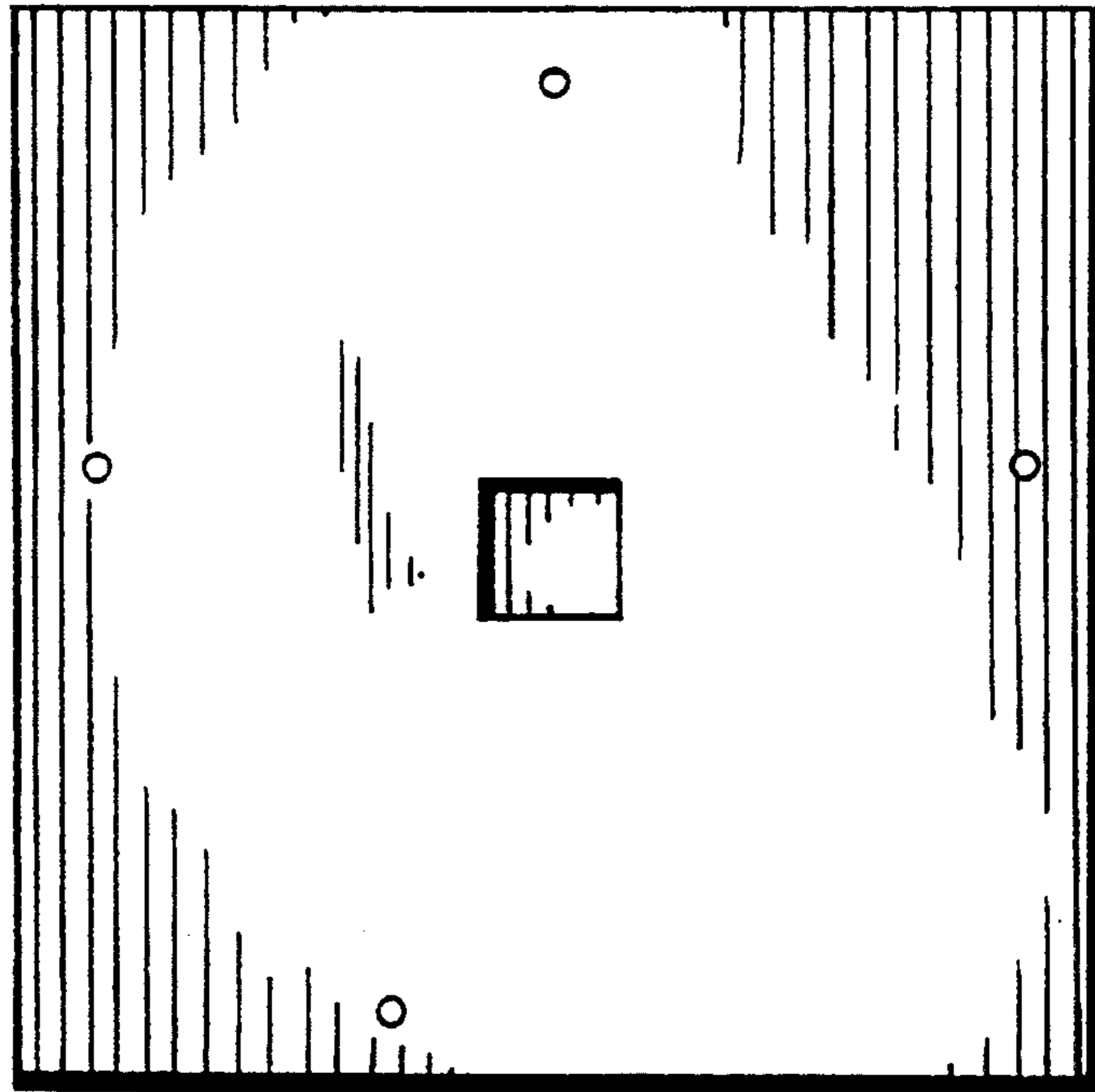


Fig. 6

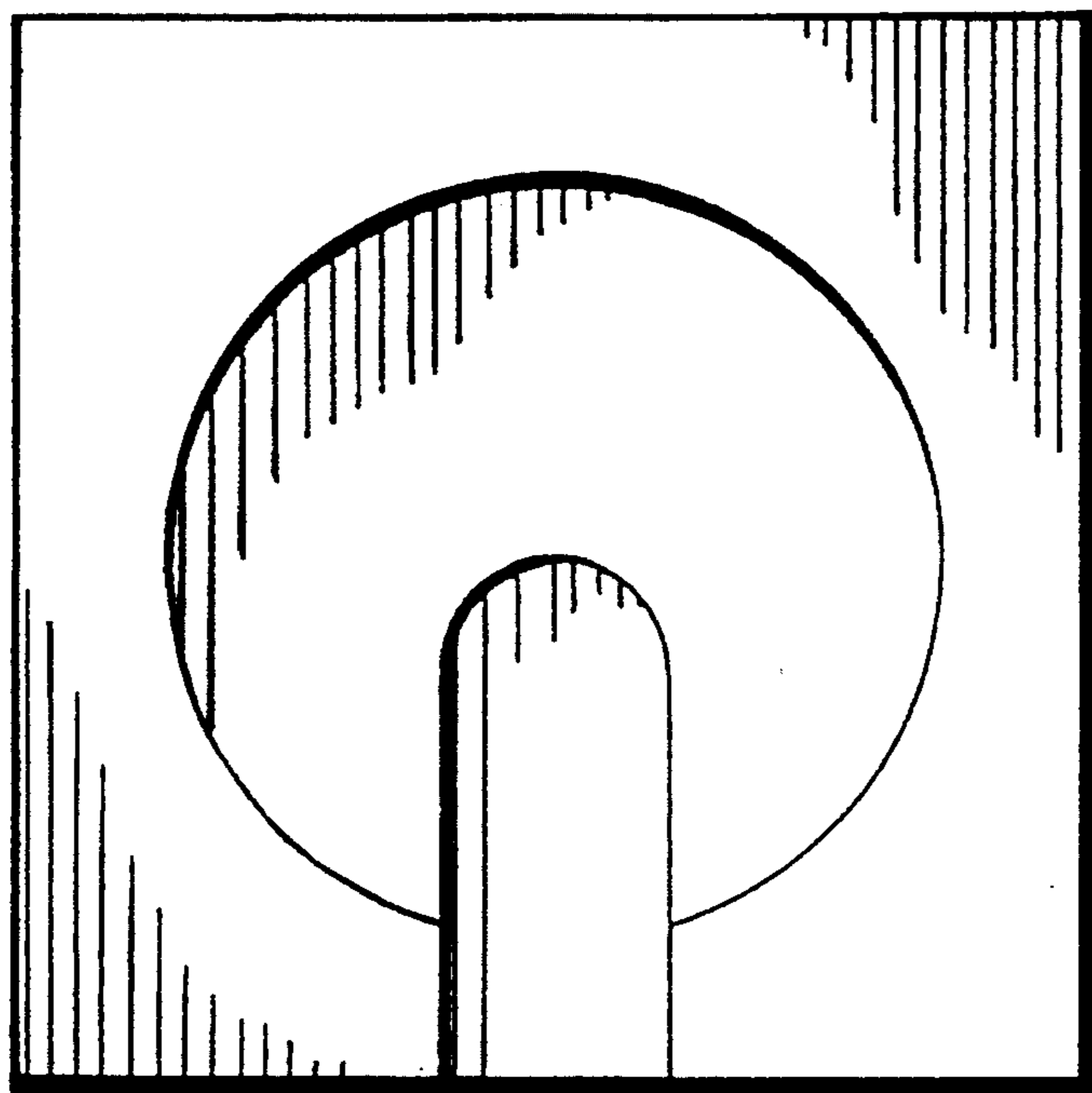


Fig. 7